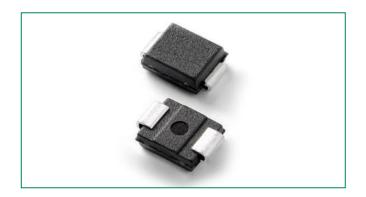


PLED Ultra Low Holding Current Series

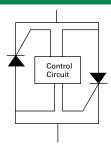




Description

This PLED ultra-low holding current series exhibits a low holding current parameter that makes it compatible with LED lighting strings. The series provide a switching electronic characteristics for an fluorescent tube replacement by an LED string. It helps to make the Fluorescent ballast and LED string compatible with each other. This ensures the ballast will be able to activate the LED string; especially for those ballast that need a high voltage output detection during ignition. The PLED ultralow I makes the LED driver widely used in the output of fluorescent tubes a compatible direct replacement for indoor and outdoor LED lighting strings.

Schematic Symbol



Features & Benefits

- Fast switching
- Automatically resets after power cycle
- Available in low profile, Standard DO-214AA packages
- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC 801-2)
- Compatible with industrial lighting environments
- RoHS compliant and halogen-free

Electrical Characteristics (All parameters are measured at T_A=25°C unless otherwise noted)

Part Number	Marking		, _{BR} :down	V_{DRM}	I _H	I _s	V _T @ I _T = 1 Amp	l _o ¹	Critical rate of rise dV/dt
		Volts		Volts	mAmps	mAmps	Volts	Amps	Volts
		Min	Max	Min	Max	Max	Max	Max	Min
PLED64S	PL64	58	71	56	21	800	2	1.0	250V/µs
PLED70S	PL70	65	81	63	21	800	2	1.0	250V/µs
PLED90S	PL90	75	90	73	21	800	2	1.0	250V/µs
PLED110S	PL110	90	120	87	21	800	2	1.0	250V/µs
PLED130S	PL130	120	149	116	21	800	2	1.0	250V/µs
PLED150S	PL150	136	167	132	21	800	2	1.0	250V/µs
PLED180S	PL180	170	203	165	21	800	2	1.0	250V/µs
PLED230S	PL230	190	240	184	21	800	2	1.0	250V/µs
PLED260S	PL260	220	274	213	21	800	2	1.0	250V/µs
PLED310S	PL310	275	330	267	21	800	2	1.0	250V/µs
PLED350S	PL350	320	380	310	21	800	2	1.0	250V/µs
PLED380S	PL380	350	430	340	21	800	2	1.0	250V/µs
PLED450S ²	PL450	410	495	397	21	800	2	1.0	250V/µs
PLED480S ²	PL480	450	600	436	21	800	2	1.0	250V/µs

Specifications are subject to change without notice

Revision: 10/15/18

^{1.} Io- Operation current tested @ aluminum boards, ambient temp 85°C

^{2.} PLED450S and PLED480S are still under developed, please contact local sales representative for further information

Thermal Considerations

Package	Symbol	Parameter	Value	Unit
DO-214	TJ	Operating Junction Temperature Range	-40 to +125	°C
DU-214	T _s	Storage Temperature Range	-65 to +150	°C
	R _{eJA}	Thermal Resistance: Junction to Ambient	90¹ 40²	°C/W

Notes

1) Standard FR-4 PCB with Copper Pads (Recommended Size)

2) Aluminum PCB

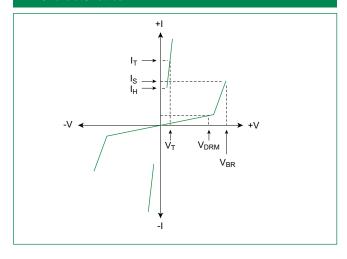
Thickness: 1.6mm Grade: 1-2 W/mK Thermal Conductivity

Trace thickness: 2 oz

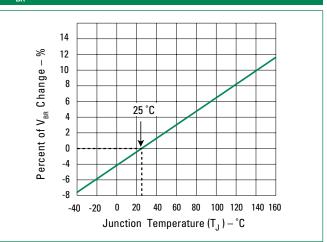
Insulation layer thickness: 215 um

Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

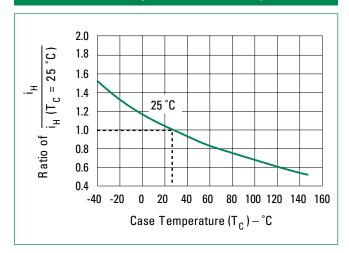
V-I Characteristics



V_{BR} vs. Junction Temperature



Normalized DC Holding Current vs. Case Temperature



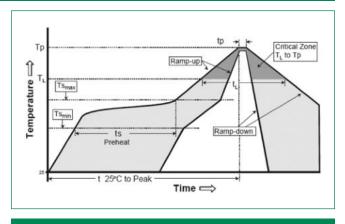
PLED Application in Ballast Output LED Driver for Ignition PLED Ultra Low Holding Current Series

Soldering Parameters

Reflow Co	ndition	Pb – Free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (min to max) (t _s)	60 – 180 secs		
Average ra	amp up rate (Liquidus Temp k	3°C/second max		
$T_{S(max)}$ to T_{L}	- Ramp-up Rate	3°C/second max		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with	in 5°C of actual peak ıre (t _p)	30 seconds		
Ramp-dow	vn Rate	6°C/second max		
Time 25°C	to peakTemperature (T _P)	8 minutes max		
Do not exc	ceed	260°C		



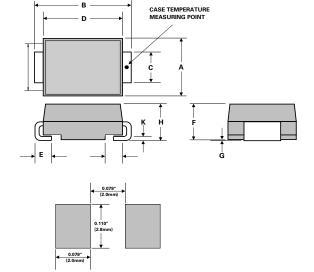
Terminal Material	Copper Alloy	
Terminal Finish	100% Matte Tin Plated	
Body Material	UL Recognized compound meeting flammability rating V-0.	



Environmental Specifications

High Temperature Voltage Blocking	MIL-STD-750: Method 1040, Condition A 80% min V _{DRM} (VAC-peak), 125°C,1008 hours			
Temperature Cycling	MIL-STD-750: Method 1051,-55°C to 150°C, 15-minute dwell,1000 cycles			
Biased Temperature & Humidity	EIA/JEDEC: JESD22-A101 52VDC, 85°C, 85%RH, 1008 hours			
Thermal Shock	MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles			
Resistance to Solder Heat	MIL-STD-750: Method 2031 260°C, 10 seconds			
Moisture Sensitivity Level	85%RH, +85°C, 168 hours, 3 reflow cycles (+260°C peak). JEDEC-J-STD-020, Level 1			

Dimensions - DO-214 AA Package

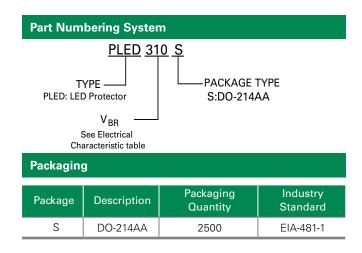


Recommended solder pad layout
(Reference Only)

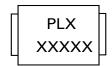
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Dimensions	Incl	hes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.130	0.156	3.30	3.95	
В	0.201	0.220	5.10	5.60	
С	0.077	0.087	1.95	2.20	
D	0.159	0.181	4.05	4.60	
E	0.030	0.063	0.75	1.60	
F	0.075	0.096	1.90	2.45	
G	0.002	0.008	0.05	0.20	
Н	0.077	0.104	1.95	2.65	
K	0.006	0.016	0.15	0.41	

PLED Application in Ballast Output LED Driver for IgnitionPLED Ultra Low Holding Current Series

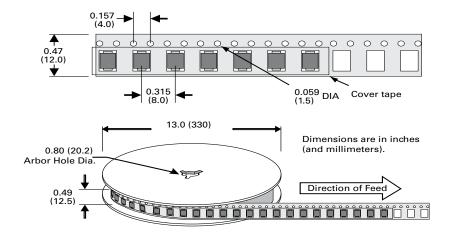


Part Marking System



DO-214 Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards



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